## TinyLogic UHS 1-of-2 Decoder / Demultiplexer

## NC7SZ19

## Description

The NC7SZ19 is a $1-$ of -2 decoder with a common output enable. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad $\mathrm{V}_{\mathrm{CC}}$ operating range. The device is specified to operate over the 1.65 V to $5.5 \mathrm{~V} \mathrm{~V}_{\mathrm{CC}}$ range. The inputs and outputs are high impedance when $\mathrm{V}_{\mathrm{CC}}$ is 0 V . Inputs tolerate voltages up to 5.5 V independent of $\mathrm{V}_{\mathrm{CC}}$ operating voltage.

## Features

- Ultra High-Speed: $t_{\mathrm{PD}}=2.7 \mathrm{~ns}$ Typical at $5 \mathrm{~V}_{\mathrm{CC}}$
- Broad $\mathrm{V}_{\mathrm{CC}}$ Operating Range: 1.65 V to 5.55 V
- Power Down High Impednce Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak ${ }^{\text {TM }}$ Packages
- Space Saving SC-88 6-Lead Package
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant

(Note: Microdot may be in either location)
*Date Code orientation and/or position may vary depending upon manufacturing location.


## ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

## Pin Configurations



Figure 1. SC-88 (Top View)


NOTES:

1. AAA represents product code top mark (see Ordering Information).
2. Orientation of top mark determines pin one location.
3. Reading the top mark left to right, pin one is the lower left pin.

Figure 3. Pin 1 Orientation

PIN DEFINITIONS

| Pin \# SC-88 | Pin \# MicroPak | Name | Description |
| :---: | :---: | :---: | :--- |
| 1 | 1 | A | Decoder Address / <br> Demultiplexer Select |
| 2 | 2 | GND | Ground |
| 3 | 3 | E | Decoder Output Enable / <br> Demultiplexer Data |
| 4 | 4 | $\mathrm{Y}_{1}$ | Output |
| 5 | 5 | $\mathrm{~V}_{\mathrm{CC}}$ | Supply Voltage |
| 6 | 6 | $\mathrm{Y}_{0}$ | Output |



Figure 2. MicroPak (Top Through View)

NC7SZ19

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage |  | -0.5 | 6.5 | V |
| $\mathrm{V}_{\text {IN }}$ | DC Input Voltage |  | -0.5 | 6.5 | V |
| $\mathrm{V}_{\text {OUT }}$ | DC Output Voltage |  | -0.5 | 6.5 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | DC Input Diode Current | $\mathrm{V}_{\text {IN }}<0 \mathrm{~V}$ | - | -50 | mA |
| IOK | DC Output Diode Current | $\mathrm{V}_{\text {OUT }}<0 \mathrm{~V}$ | - | -50 | mA |
| IOUT | DC Output Current |  | - | $\pm 50$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ or $\mathrm{I}_{\text {GND }}$ | DC V ${ }_{\text {CC }}$ or Ground Current |  | - | $\pm 50$ | mA |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction Temperature Under Bias |  | - | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Junction Lead Temperature (Soldering, 10 Seconds) |  | - | +260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air | SC-88 | - | 332 | mW |
|  |  | MicroPak-6 | - | 812 |  |
|  |  | MicroPak2 ${ }^{\text {TM }}$-6 | - | 812 |  |
| ESD | Human Body Model, JEDEC: JESD22-A114 |  | - | 4000 | V |
|  | Charge Device Model, JEDEC: JESD22-C101 |  | - | 2000 |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage Operating |  | 1.65 | 5.50 | V |
|  | Supply Voltage Data Retention |  | 1.5 | 5.5 |  |
| $\mathrm{V}_{\text {IN }}$ | Input Voltage |  | 0 | 5.5 | V |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage |  | 0 | $\mathrm{V}_{C C}$ | V |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Input Rise and Fall Times | $\mathrm{V}_{\mathrm{CC}}$ at $1.8 \mathrm{~V} \pm 0.15 \mathrm{~V}, 2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}$ | 0 | 20 | $\mathrm{ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\text {CC }}$ at $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | 0 | 10 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}$ at $5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ | 0 | 5 |  |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance | SC-88 | - | 377 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | MicroPak-6 | - | 154 |  |
|  |  | MicroPak2-6 | - | 154 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTICAL CHARACTERISTICS

| Symbol | Parameter | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | Conditions | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH Level Input Voltage | 1.65 to 1.95 |  | $0.65 \mathrm{~V}_{\mathrm{CC}}$ | - | - | $0.65 \mathrm{~V}_{\mathrm{CC}}$ | - | V |
|  |  | 2.30 to 5.50 |  | $0.70 \mathrm{~V}_{\mathrm{CC}}$ | - | - | $0.70 \mathrm{~V}_{\mathrm{CC}}$ | - |  |
| $\mathrm{V}_{\text {IL }}$ | LOW Level Input Voltage | 1.65 to 1.95 |  | - | - | $0.35 \mathrm{~V}_{\mathrm{CC}}$ | - | $0.35 \mathrm{~V}_{\mathrm{CC}}$ | V |
|  |  | 2.30 to 5.50 |  | - | - | $0.30 \mathrm{~V}_{\mathrm{CC}}$ | - | $0.30 \mathrm{~V}_{\mathrm{Cc}}$ |  |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH Level Output Voltage | 1.65 | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}}, \text { or } \mathrm{V}_{\mathrm{IL}}, \\ & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A} \end{aligned}$ | 1.55 | 1.65 | - | 1.55 | - | V |
|  |  | 2.30 |  | 2.20 | 2.30 | - | 2.20 | - |  |
|  |  | 3.00 |  | 2.90 | 3.00 | - | 2.90 | - |  |
|  |  | 4.50 |  | 4.40 | 4.50 | - | 4.40 | - |  |
|  |  | 1.65 | $\mathrm{l}_{\mathrm{OH}}=-4 \mathrm{~mA}$ | 1.29 | 1.52 | - | 1.29 | - |  |
|  |  | 2.30 | $\mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA}$ | 1.90 | 2.15 | - | 1.90 | - |  |
|  |  | 3.00 | $\mathrm{I}_{\mathrm{OH}}=-16 \mathrm{~mA}$ | 2.40 | 2.80 | - | 2.40 | - |  |
|  |  | 3.00 | $\mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA}$ | 2.30 | 3.68 | - | 2.30 | - |  |
|  |  | 4.50 | $\mathrm{I}_{\mathrm{OH}}=-32 \mathrm{~mA}$ | 3.80 | 4.20 | - | 3.80 | - |  |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW Level Output Voltage | 1.65 | $\begin{aligned} & V_{I N}=V_{I H}, \text { or } V_{I L}, \\ & l_{\mathrm{OL}}=100 \mu \mathrm{~A} \end{aligned}$ | - | 0.00 | 0.10 | - | 0.10 | V |
|  |  | 2.30 |  | - | 0.00 | 0.10 | - | 0.10 |  |
|  |  | 3.00 |  | - | 0.00 | 0.10 | - | 0.10 |  |
|  |  | 4.50 |  | - | 0.00 | 0.10 | - | 0.10 |  |
|  |  | 1.65 | $\mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$ | - | 0.08 | 0.24 | - | 0.24 |  |
|  |  | 2.30 | $\mathrm{I}_{\mathrm{OL}}=8 \mathrm{~mA}$ | - | 0.10 | 0.30 | - | 0.30 |  |
|  |  | 3.00 | $\mathrm{l}_{\mathrm{OL}}=16 \mathrm{~mA}$ | - | 0.15 | 0.40 | - | 0.40 |  |
|  |  | 3.00 | $\mathrm{IOL}^{\text {a }} 24 \mathrm{~mA}$ | - | 0.22 | 0.55 | - | 0.55 |  |
|  |  | 4.50 | $\mathrm{I}_{\mathrm{OL}}=32 \mathrm{~mA}$ | - | 0.22 | 0.55 | - | 0.55 |  |
| IIN | Input Leakage Current | 1.65 to 5.5 | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$, GND | - | - | $\pm 0.1$ | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| IOFF | Power Off Leakage Current | 0 | $\mathrm{V}_{\text {IN }}$ or $\mathrm{V}_{\text {OUT }}=5.5 \mathrm{~V}$ | - | - | 1 | - | 10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC}}$ | Quiescent Supply Current | 1.65 to 5.50 | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$, GND | - | - | 1 | - | 10 | $\mu \mathrm{A}$ |

AC ELECTRICAL CHARACTERISTICS

|  | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Conditions | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol |  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | Propagation Delay A or /E to Output (Figure 5, 6) | $1.80 \pm 0.15$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega \end{aligned}$ | - | 5.9 | 10.5 | - | 11.0 | ns |
|  |  | $2.50 \pm 0.20$ |  | - | 3.5 | 6.0 | - | 6.4 |  |
|  |  | $3.30 \pm 0.30$ |  | - | 2.7 | 4.1 | - | 4.5 |  |
|  |  | $5.00 \pm 0.50$ |  | - | 2.1 | 3.2 | - | 3.5 |  |
|  |  | $3.30 \pm 0.30$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \\ & \mathrm{R}_{\mathrm{L}}=500 \Omega \end{aligned}$ | - | 3.2 | 5.1 | - | 5.4 | ns |
|  |  | $5.00 \pm 0.50$ |  | - | 2.7 | 4.0 | - | 4.3 |  |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance | 0 |  | - | 2.3 | - | - | - | pF |
| CPD | Power Dissipation Capacitance (Note 4) (Figure 5) | 3.30 |  | - | 10.5 | - | - | - | pF |
|  |  | 5.00 |  | - | 12.8 | - | - | - |  |

4. $\mathrm{C}_{P D}$ is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I $\mathrm{I}_{C C D}$ ) at no output loading and operating at $50 \%$ duty cycle. $\mathrm{C}_{P D}$ is related to $\mathrm{I}_{\mathrm{CCD}}$ dynamic operating current by the expression:
$\mathrm{I}_{\mathrm{CCD}}=\left(\mathrm{C}_{\mathrm{PD}}\right)\left(\mathrm{V}_{\mathrm{CC}}\right)\left(\mathrm{f}_{\mathrm{IN}}\right)+\left(\mathrm{I}_{\mathrm{CC}}\right.$ Static $)$.

## AC Loading and Waveforms



NOTES:
5. $C_{L}$ includes load and stray capacitance.
6. Input $\mathrm{PRR}=1.0 \mathrm{MHz}, \mathrm{t}_{\mathrm{w}}=500 \mathrm{~ns}$.

Figure 4. AC Test Circuit


NOTE:
7. Input $=\mathrm{AC}$ Waveform; $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=1.8 \mathrm{~ns}$.
8. $\operatorname{PRR}=10 \mathrm{MHz}$; Duty Cycle $=50 \%$.
9. $/ E$ Input $=$ GND.

Figure 5. ICCD Test Circuit


Figure 6. AC Waveforms

ORDERING INFORMATION

| Device | Top Mark | Packages | Shipping $^{\dagger}$ |
| :--- | :---: | :---: | :---: |
| NC7SZ19P6X | Z19 | 6-Lead SC70, EIAJ SC88, 1.25 mm Wide | $3000 /$ Tape \& Reel |
| NC7SZ19P6X-L22347 | Z19 | 6-Lead SC70, EIAJ SC88, 1.25 mm Wide | $3000 /$ Tape \& Reel |
| NC7SZ19L6X | B4 | 6-Lead MicroPak, 1.00 mm Wide | $5000 /$ Tape \& Reel |
| NC7SZ19L6X-L22175 | B4 | 6-Lead MicroPak, 1.00 mm Wide | $5000 /$ Tape \& Reel |
| NC7SZ19FHX | B4 | 6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch | $5000 /$ Tape \& Reel |
| NC7SZ19FHX-L22175 | B4 | 6-Lead, MicroPak2, 1x1 mm Body, . 35 mm Pitch | $5000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


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| DESCRIPTION: | SIP6 1.45X1.0 | PAGE 1 OF 1 |

SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02
ISSUE Z

DATE 18 APR 2024

TOP VIEW


NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018
. ALL DIMENSION ARE IN MILLIMETERS
2. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
3. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
4. DATUMS A AND B ARE DETERMINED AT DATUM H
5. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.


RECOMMENDED MOUNTING FOOTPRINT*
FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.


GENERIC MARKING DIAGRAM*


| DIM | MILLIMETERS |  |  |
| :--- | :--- | :--- | :--- |
|  | MIN. | NOM. | MAX. |
| A | --- | --- | 1.10 |
| A1 | 0.00 | --- | 0.10 |
| A2 | 0.70 | 0.90 | 1.00 |
| $b$ | 0.15 | 0.20 | 0.25 |
| $c$ | 0.08 | 0.15 | 0.22 |
| D | 2.00 BSC |  |  |
| E | 2.10 BSC |  |  |
| E1 | 1.25 BSC |  |  |
| $e$ | 0.65 BSC |  |  |
| L | 0.26 | 0.36 | 0.46 |
| L2 | 0.15 BSC |  |  |
| aaa | 0.15 |  |  |
| bbb | 0.30 |  |  |
| ccc | 0.10 |  |  |
| ddd | 0.10 |  |  |

XXX = Specific Device Code
M = Date Code*

- = Pb-Free Package
(Note: Microdot may be in either location)
*Date Code orientation and/or position may vary depending upon manufacturing location.
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " r ", may or may not be present. Some products may not follow the Generic Marking.


## STYLES ON PAGE 2

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | SC-88 2.00×1.25x0.90, 0.65P | PAGE 1 OF 2 |

[^0]STYLE 1:
PIN 1. EMITTER 2
2. BASE 2
3. COLLECTOR 1
4. EMITTER 1
5. BASE 1
6. COLLECTOR 2

STYLE 7:
PIN 1. SOURCE 2
2. DRAIN 2
3. GATE 1
4. SOURCE 1
5. DRAIN 1
6. GATE 2

STYLE 13:
PIN 1. ANODE
2. N/C
3. COLLECTOR
4. EMITTER
5. BASE
6. CATHODE

STYLE 19:
PIN 1. IOUT
2. GND
3. GND
4. V CC
5. V EN
6. V REF
STYLE 25:
PIN 1. BASE 1
2. CATHODE
3. COLECTOR 2
4. BASE 2
5. EMITTER
6. COLLECTOR 1
STYLE 2:
CANCELLED

STYLE 8:
CANCELLED

STYLE 14:
PIN 1. VREF
2. GND
3. GND
4. IOUT
5. VEN
6. VCC

STYLE 20:
PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR
STYLE 26:

| STYLE 3 : CANCELLED | STYLE 4: <br> PIN 1. CATHODE <br> 2. CATHODE <br> 3. COLLECTOR <br> 4. EMITTER <br> 5. BASE <br> 6. ANODE | STYLE 5: <br> PIN 1. ANODE <br> 2. ANODE <br> 3. COLLECTOR <br> 4. EMITTER <br> 5. BASE <br> 6. CATHODE | STYLE 6 : <br> PIN 1. ANODE 2 <br> 2. $\mathrm{N} / \mathrm{C}$ <br> 3. CATHODE 1 <br> 4. ANODE 1 <br> 5. N/C <br> 6. CATHODE 2 |
| :---: | :---: | :---: | :---: |
| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: |
| PIN 1. EMITTER 2 | PIN 1. SOURCE 2 | PIN 1. CATHODE 2 | PIN 1. ANODE 2 |
| 2. EMITTER 1 | 2. SOURCE 1 | 2. CATHODE 2 | 2. ANODE 2 |
| 3. COLLECTOR 1 | 3. GATE 1 | 3. ANODE 1 | 3. CATHODE 1 |
| 4. BASE 1 | 4. DRAIN 1 | 4. CATHODE 1 | 4. ANODE 1 |
| 5. BASE 2 | 5. DRAIN 2 | 5. CATHODE 1 | 5. ANODE 1 |
| 6. COLLECTOR 2 | 6. GATE 2 | 6. ANODE 2 | 6. CATHODE 2 |
| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: |
| PIN 1. ANODE 1 | PIN 1. BASE 1 | PIN 1. BASE 1 | PIN 1. VIN1 |
| 2. ANODE 2 | 2. EMITTER 2 | 2. EMITTER 1 | 2. VCC |
| 3. ANODE 3 | 3. COLLECTOR 2 | 3. COLLECTOR 2 | 3. VOUT2 |
| 4. CATHODE 3 | 4. BASE 2 | 4. BASE 2 | 4. VIN2 |
| 5. CATHODE 2 | 5. EMITTER 1 | 5. EMITTER 2 | 5. GND |
| 6. CATHODE 1 | 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. VOUT1 |
| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: |
| PIN 1. ANODE 1 | PIN 1. D1 (i) | PIN 1. Vn | PIN 1. CATHODE |
| 2. $\mathrm{N} / \mathrm{C}$ | 2. GND | 2. CH 1 | 2. ANODE |
| 3. ANODE 2 | 3. D2 (i) | 3. Vp | 3. CATHODE |
| 4. CATHODE 2 | 4. D2 (c) | 4. N/C | 4. CATHODE |
| 5. N/C | 5. VBUS | 5. CH 2 | 5. CATHODE |
| 6. CATHODE 1 | 6. D1 (c) | 6. N/C | 6. CATHODE |
| STYLE 27: | STYLE 28 : | STYLE 29: | STYLE 30: |
| PIN 1. BASE 2 | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. SOURCE 1 |
| 2. BASE 1 | 2. DRAIN | 2. ANODE | 2. DRAIN 2 |
| 3. COLLECTOR 1 | 3. GATE | 3. COLLECTOR | 3. DRAIN 2 |
| 4. EMITTER 1 | 4. SOURCE | 4. EMITTER | 4. SOURCE 2 |
| 5. EMITTER 2 | 5. DRAIN | 5. BASE/ANODE | 5. GATE 1 |
| 6. COLLECTOR 2 | 6. DRAIN | 6. CATHODE | 6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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